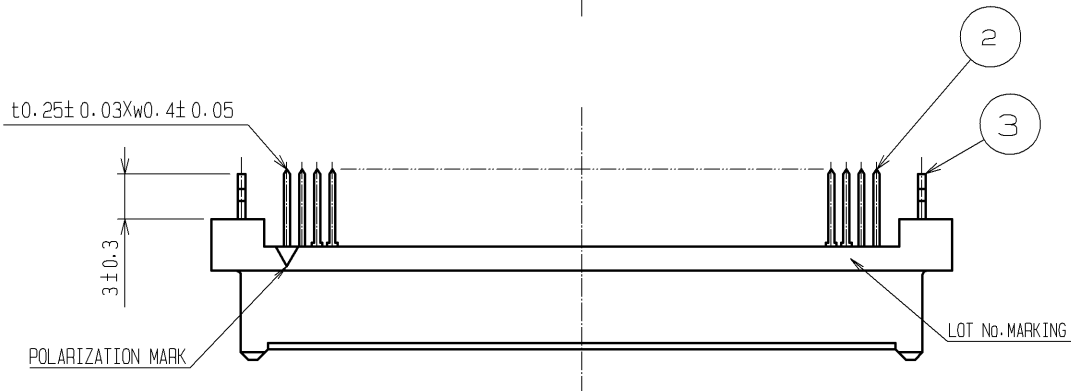
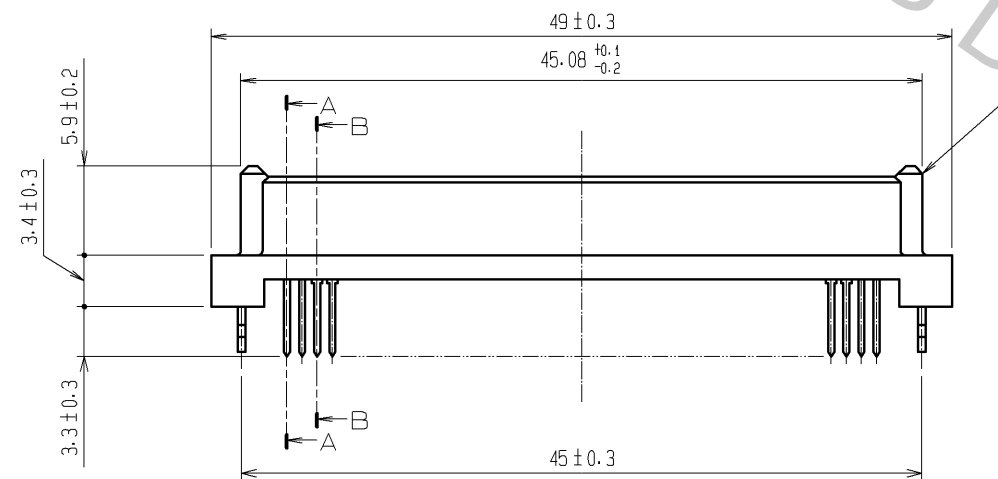
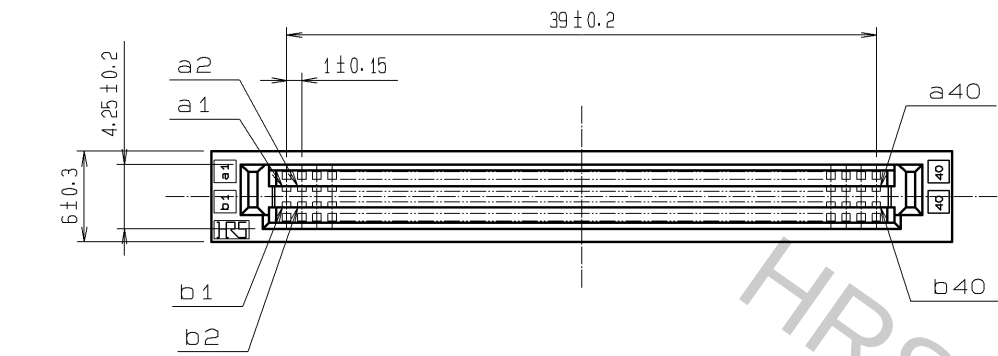
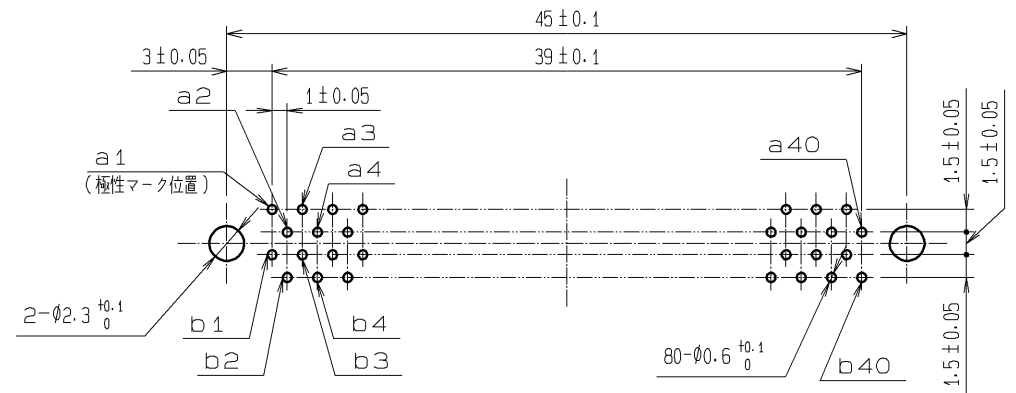




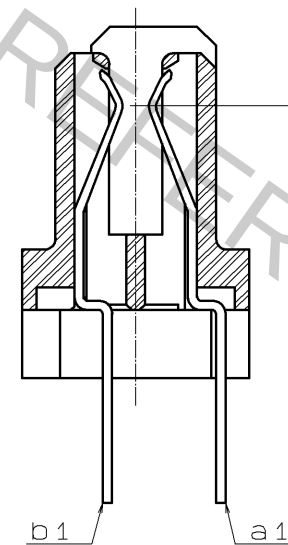
RECOMMENDED PC BOARD HOLE PATTERN (MOUNTING SIDE)
APPLICABLE BOARD THICKNESS: 1.6



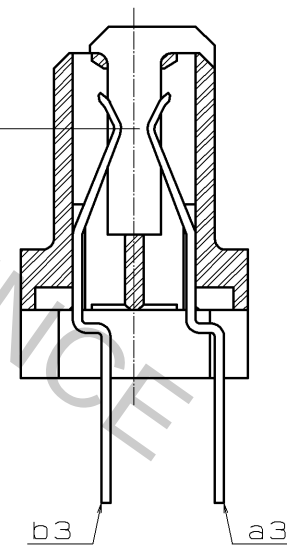
CONTACT SEQUENCE

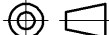
SEQUENCE	PIN NO.
1	a1, a2, a39, a40 b1, b2, b39, b40
2	a3~a38 b3~b38

A-A (5:1)



B-B (5:1)



3	PHOSPHOR BRONZE	TIN-PLATING		2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.						
1	POLYAMIDE	BEIGE UL94V-0				LEAD AREA : TIN-PLATING 1.2μm min.						
						UNDER PLATING : NICKEL 1μm min.						
NO.		MATERIAL		FINISH . REMARKS		NO.	MATERIAL		FINISH . REMARKS			
UNITS mm				SCALE 2 : 1			COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		08. 07. 14		DRAWING NO.		EDC3-151520-21				
		CHECKED : HT. YAMAGUCHI		08. 07. 14		PART NO.		FX5-80S2A-DSAL(71)				
		DESIGNED : SY. KAMIGA		08. 07. 11		CODE NO.		CL575-0129-0-71				
		DRAWN : HK. SUNADORI		08. 06. 19				 1/1				

HRS HIROSE ELECTRIC CO., LTD.